



Product Change Notification

Change Notification #: 116378 - 00
Change Title: Select Intel® Xeon Phi™ Processors:
7210, 7210F, 7230, 7230F, 7250, 7250F,
7290, and 7290F,
PCN 116378-00, Product Discontinuance,
End of Life
Date of Publication: July 23, 2018

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	July 23, 2018
Last Product Discontinuance Order Date:	August 31, 2018
Orders are Non-Cancelable and Non-Returnable After:	August 31, 2018
Last Product Discontinuance Shipment Date:	July 19, 2019

Description of Change to the Customer:

Market demand for the products listed in the "Products Affected/Intel Ordering Codes" table below have shifted to other Intel products. The products identified in this notification will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date" (see "Key Milestones" above).

Customer Impact of Change and Recommended Action:

The products listed on the "Products Affected/Intel Ordering Codes" table should be managed in accordance to the "Key Milestones" listed above. The "Last Product Discontinuance Order Date" is the final day for customers who carry backlog to book the Assurance Intel has granted as of the "Orders are Non-Cancellable and Non-Returnable After" (NCNR) date. NCNR date applies to both Corporate Assurance and backlog after the "Last Product Discontinuance Order Date." At this date a snapshot will be taken of all remaining backlog and/or assurance and this quantity will become non-cancellable. For all customers Corporate Assurance must be booked and shipped by the "Last Product Discontinuance Shipment Date." From date of PCN publication, interim booking and turn back deadlines or separate Letter Agreements will apply vs. the standard Corporate Assurance Process.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#
Intel® Xeon Phi™ Processor 7210	HJ8066702859300	S R2X4	951272
Intel® Xeon Phi™ Processor 7210F	HJ8066702975000	S R2X5	951274
Intel® Xeon Phi™ Processor 7230	HJ8066702859400	S R2X3	951270
Intel® Xeon Phi™ Processor 7230F	HJ8066702269002	S R2X2	951268
Intel® Xeon Phi™ Processor 7250	HJ8066702859200	S R2X1	951266
Intel® Xeon Phi™ Processor 7250F	HJ8066702268900	S R2X0	951264
Intel® Xeon Phi™ Processor 7290	HJ8066702974700	S R2WY	951260
Intel® Xeon Phi™ Processor 7290F	HJ8066702975200	S R2WZ	951262

PCN Revision History:

Date of Revision:

July 23, 2018

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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